



Computing and Artificial Intelligence for Visual Data Analysis II

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Deadline for manuscript
submissions:

closed (20 December 2022)

Message from the Guest Editors

Owing to recent advances in the growing capability and speed of processing large amounts of data, computing and artificial intelligence have been receiving increased attention and playing important roles in many application fields, such as surveillance, intelligent transportation systems, virtual/augmented reality, robotics and autonomous systems, smart healthcare, and so forth. Furthermore, advancements in the era of big data have given rise to an extensive variety of impressive applications by utilizing big data and established, demanding research and development issues.

This Special Issue aims at disseminating recent advances in the theory and applications of computing and artificial intelligence. We cordially invite authors to submit papers presenting original contributions in the field of visual intelligence.

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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